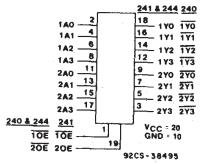
#### **Advance Information**



Data sheet acquired from Harris Semiconductor SCHS287B – Revised January 2004



# Octal Buffer/Line Drivers, 3-State

CD54/74AC/ACT240 - Inverting CD54/74AC/ACT241 - Non-Inverting CD54/74AC/ACT244 - Non-Inverting

#### **Type Features:**

- Buffered inputs
- Typical propagation delay: 3.6 ns @ Vcc = 5 V, T<sub>A</sub> = 25° C, C<sub>L</sub> = 50 pF

# FUNCTIONAL DIAGRAM & TERMINAL ASSIGNMENT

The RCA CD54/74AC240, CD54/74AC241, and CD54/74AC244 and the CD54/74ACT240, CD54/74ACT241, and CD54/74ACT244 3-state octal buffer/line drivers use the RCA ADVANCED CMOS technology. The CD54/74AC/ACT240 and CD54/74AC/ACT244 have active-LOW output enables (10E, 20E). The CD54/74AC/ACT241 has one active-LOW (10E) and one active-HIGH (20E) output enable.

The CD74AC240 and CD74ACT240 are supplied in 20-lead dual-in-line plastic packages (E suffix) and 20-lead small-outline packages (M and M96 suffixes). The CD74AC241 is supplied in 20-lead dual-in-line plastic packages (E suffix) and the CD74ACT241 is supplied in 20-lead dual-in-line plastic packages (E suffix) and 20-lead small-outline packages (M96 suffix). The CD74AC244 and CD74ACT244 are supplied in 20-lead dual-in-line plastic packages (E suffix), 20-lead small-outline packages (M and M96 suffixes), and 20-lead shrink small-outline packages (SM96 suffix). These package types are operable over the following temperature ranges: Commerical (0 to 70°C); Industrial (–40 to +85°C); and Extended Industrial/Military (–55 to + 125°C).

The CD54AC240 and CD54AC244 and the CD54ACT240, CD54ACT241, and CD54ACT244 are supplied in 20-lead hermetic dual-in-line ceramic packages (F3A suffix) and are operable over the -55 to +125°C temperature range.

#### **Family Features:**

- Exceeds 2-kV ESD Protection MIL-STD-883, Method 3015
- SCR-Latch-up-resistant CMOS process and circuit design
- Speed of bipolar FAST\*/AS/S with significantly reduced power consumption
- Balanced propagation delays
- AC types feature 1.5-V to 5.5-V operation and balanced noise immunity at 30% of the supply
- ± 24-mA output drive current
  - Fanout to 15 FAST\* ICs
  - Drives 50-ohm transmission lines

#### TRUTH TABLES

|          | INPUTS     |   |  |  |
|----------|------------|---|--|--|
| 10E, 20E | 10E, 20E A |   |  |  |
| L        | L          | Н |  |  |
| L        | Н          | L |  |  |
| Н        | X          | Z |  |  |

(AC/ACT240)

| INPU     | ITS | OUTPUT |
|----------|-----|--------|
| 10E, 20E | Α   | Y      |
| L        | , r | L      |
| L        | Н   | Н      |
| н        | X   | Z      |

(AC/ACT244)

| INP | UTS | OUTPUT | TPUT INPUTS |    | OUTPUT INPUTS |  | OUTPUT |
|-----|-----|--------|-------------|----|---------------|--|--------|
| 10E | 1A  | 1Y     | 20E         | 2A | 2Y            |  |        |
| L   | L   | L      | L           | Х  | Z             |  |        |
| L   | н   | H      | н           | L  | L             |  |        |
| Н   | х   | Z      | Н           | н  | н             |  |        |

(AC/ACT241)

H = HIGH Voltage Level L = LOW Voltage Level X = Immaterial

Z = HIGH Impedance

This data sheet is applicable to the CD54/74AC240, CD54ACT240, and CD54/74ACT241. The CD54/74AC241 were not acquired from Harris Semiconductor. See SCHS244 for information on the CD74ACT240, CD74AC244, and CD74ACT244. Copyright © 2004, Texas Instruments Incorporated

<sup>\*</sup>FAST is a Registered Trademark of Fairchild Semiconductor Corp.

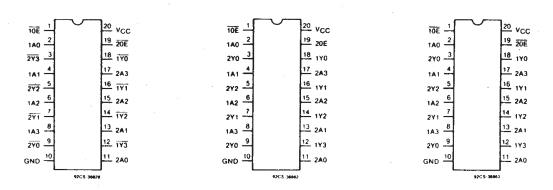
| MAXIMUM RATINGS, Absolute-Maximum Values:  |
|--|
| DC SUPPLY-VOLTAGE (V∞)0.5 to 6 V   |
| DC INPUT DIODE CURRENT, $I_{iK}$ (for $V_1 < -0.5 \text{ V}$ or $V_1 > V_{CC} + 0.5 \text{ V}$ )   |
| DC OUTPUT DIODE CURRENT, $l_{OK}$ (for $V_0 < -0.5$ V or $V_0 > V_{cc} + 0.5$ V)   |
| DC OUTPUT SOURCE OR SINK CURRENT per Output Pin, Io (for Vo > -0.5 V or Vo < Vcc + 0.5 V)  |
| DC V <sub>CC</sub> or GROUND CURRENT (I <sub>CC</sub> or I <sub>GND</sub> )  |
| POWER DISSIPATION PER PACKAGE (PD):  |
| For T <sub>A</sub> = -40 to +85°C (Package Type E)   |
| For T <sub>A</sub> = -40 to +70°C (Package Type M)   |
|  |
| For T <sub>A</sub> = +70 to +85°C (Package Type M)   |
| For T <sub>A</sub> = +70 to +85°C (Package Type M)   |
|  |
| OPERATING-TEMPERATURE RANGE (TA): CD54      55 to +125°C         CD74      40 to +85°C   |
| OPERATING-TEMPERATURE RANGE (T <sub>A</sub> ): CD5455 to +125°C  |
| $\begin{array}{lll} \text{OPERATING-TEMPERATURE RANGE (T_A): CD54} &55 \text{ to } +125^{\circ}\text{C} \\ & \text{CD74} &40 \text{ to } +85^{\circ}\text{C} \\ \text{STORAGE TEMPERATURE (T_{\text{Stg}})} &65 \text{ to } +150^{\circ}\text{C} \\ \end{array}$   |
| $\begin{array}{lll} \text{OPERATING-TEMPERATURE RANGE (T_A): CD54} &55 \text{ to } +125^{\circ}\text{C} \\ & \text{CD74} &40 \text{ to } +85^{\circ}\text{C} \\ \text{STORAGE TEMPERATURE (T_{\text{Stg}})} &65 \text{ to } +150^{\circ}\text{C} \\ \text{LEAD TEMPERATURE (DURING SOLDERING):} &65 \text{ to } +150^{\circ}\text{C} \\ \end{array}$ |

RECOMMENDED OPERATING CONDITIONS:

For maximum reliability, normal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC  |      |      | LIMITS |      |  |
|---|------|------|--------|------|--|
| CHARACTERISTIC  | MIN. | MAX. | UNITS  |      |  |
| Supply-Voltage Range, V <sub>CC</sub> *:                    |      |      |        |      |  |
| (For T <sub>A</sub> = Full Package-Temperature Range)       |      |      |        |      |  |
| AC Types  |      | 1.5  | 5.5    | V    |  |
| ACT Types   | 4.5  | 5.5  | V      |      |  |
| DC Input or Output Voltage, V <sub>I</sub> , V <sub>O</sub> |      | 0    | VCC    | V    |  |
| Operating Temperature, T <sub>A</sub>                       | CD54 | -55  | +125   | ∘c   |  |
|   | CD74 | -40  | +85    | C    |  |
| Input Rise and Fall Slew Rate, dt/dv                        |      |      |        |      |  |
| at 1.5 V to 3 V (AC Types)                                  |      | 0    | 50     | ns/V |  |
| at 3.6 v to 5.5 V (AC Types)                                |      | 0    | 20     | ns/V |  |
| at 4.5 V to 5.5 V (ACT Types)                               |      | 0    | 10     | ns/V |  |

<sup>\*</sup> Unless otherwise specified, all voltages are referenced to ground.



CD54/74AC, ACT240 TYPES TERMINAL ASSIGNMENT

CD54/74AC, ACT241 TYPES TERMINAL ASSIGNMENT CD54/74AC, ACT244 TYPES TERMINAL ASSIGNMENT

STATIC ELECTRICAL CHARACTERISTICS: AC Series

|                                  |                 |                                     |                        |                 | AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C |              |          |          |        |          |          |   |     |  |
|----------------------------------|-----------------|-------------------------------------|------------------------|-----------------|--|--------------|----------|----------|--------|----------|----------|---|-----|--|
| CHARACTERISTI                    | CS              | TEST CO                             | NDITIONS               | V <sub>cc</sub> | +:   | 25           | 40 to    | o +85    | -55 to | +125     | UNITS    |   |     |  |
|                                  |                 | V,<br>(V)                           | l <sub>o</sub><br>(mA) | (V)             | MIN.                                       | MAX.         | MIN.     | MAX.     | MIN.   | MAX.     |          |   |     |  |
| High-Level Input                 |                 |                                     |                        | 1.5             | 1.2  | _            | 1.2      |          | 1.2    |          |          |   |     |  |
| Voltage                          | VIH             |                                     |                        | 3               | 2.1  | :            | 2.1      |          | 2.1    | —        | v        |   |     |  |
|                                  |                 |                                     |                        | 5.5             | 3.85                                       | <u> </u>     | 3.85     |          | 3.85   |          |          |   |     |  |
| Low-Level Input                  |                 |                                     |                        | 1.5             | _  | 0.3          | _        | 0.3      |        | 0.3      | ·        |   |     |  |
| Voltage                          | VIL             |                                     |                        | 3               |  | 0.9          | _        | 0.9      |        | 0.9      | V        |   |     |  |
|                                  |                 |                                     |                        | 5.5             | _  | 1.65         | _        | 1.65     |        | 1.65     | <u> </u> |   |     |  |
| High-Level Output                |                 |                                     | -0.05                  | 1.5             | 1.4  | _            | 1.4      | _        | 1.4    |          |          |   |     |  |
| Voltage                          | V <sub>OH</sub> | ViH                                 | -0.05                  | 3               | 2.9  | _            | 2.9      |          | 2.9    | <u> </u> |          |   |     |  |
|                                  |                 | or                                  | -0.05                  | 4.5             | 4.4  |              | 4.4      | _        | 4.4    | _        | ]        |   |     |  |
|                                  |                 | Vil                                 | -4                     | 3               | 2.58                                       |              | 2.48     | <u> </u> | 2.4    |          | V        |   |     |  |
|                                  |                 |                                     | -24                    | 4.5             | 3.94                                       | * . <u> </u> | 3.8      | _        | 3.7    | _        |          |   |     |  |
|                                  |                 | #, * {                              | -75                    | 5.5             | _  |              | 3.85     |          | _      | <u> </u> |          |   |     |  |
|                                  |                 | "'                                  | -50                    | 5.5             | <u> </u>                                   | _            | _        | _        | 3.85   |          | <u> </u> |   |     |  |
| Low-Level Output                 |                 |                                     | 0.05                   | 1.5             | _  | 0.1          | -        | 0.1      |        | 0.1      |          |   |     |  |
| Voltage                          | Vol             | ViH                                 | 0.05                   | 3               | _  | 0.1          | _        | 0.1      | _      | 0.1      |          |   |     |  |
|                                  |                 | or                                  | 0.05                   | 4.5             |  | 0.1          |          | 0.1      | _      | 0.1      |          |   |     |  |
|                                  |                 | VIL                                 | 12                     | 3               | _  | 0.36         | _        | 0.44     | _      | 0.5      | ] v      |   |     |  |
|                                  |                 |                                     |                        |                 |  | 24           | 4.5      | _        | 0.36   | _        | 0.44     | _ | 0.5 |  |
|                                  |                 | #, * {                              | 75                     | 5.5             | _  |              | _        | 1.65     | _      | -        |          |   |     |  |
|                                  |                 | ",  ^                               | 50                     | 5.5             |  |              |          | _        | · · —  | 1.65     | 1        |   |     |  |
| Input Leakage<br>Current         | l <sub>1</sub>  | V <sub>∞</sub><br>or<br>GND         |                        | 5.5             | _  | ±0.1         | <u>.</u> | ±1       | _      | ±1       | μΑ       |   |     |  |
| 3-State Leakage<br>Current       | loz             | V <sub>IH</sub><br>or               |                        |                 |  |              |          |          |        |          |          |   |     |  |
|                                  |                 | V <sub>IL</sub><br>V <sub>O</sub> = |                        | 5.5             |  | ±0.5         | -        | ±5       | -      | ±10      | μΑ       |   |     |  |
|                                  |                 | V <sub>∞</sub><br>or<br>GND         |                        |                 |  |              |          |          |        |          |          |   |     |  |
| Quiescent Supply<br>Current, MSI | loc             | V <sub>∞</sub><br>or<br>GND         | 0                      | 5.5             | _  | 8            | _        | 80       | _      | 160      | μΑ       |   |     |  |

<sup>#</sup>Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

<sup>\*</sup>Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

#### STATIC ELECTRICAL CHARACTERISTICS: ACT Series

|   |                 |  |                        |                  | AMBIENT TEMPERATURE (TA) - °C |      |          |       |        |      |          |
|---|-----------------|--|------------------------|------------------|-------------------------------|------|----------|-------|--------|------|----------|
| CHARACTERISTI   | cs              | TEST CO  | NDITIONS               | V <sub>cc</sub>  | +                             | 25   | -40 t    | o +85 | -55 to | +125 | UNITS    |
|   |                 | V,<br>(V)  | l <sub>o</sub><br>(mA) | (V)              | MIN.                          | MAX. | MIN.     | MAX.  | MIN.   | MAX. |          |
| High-Level Input<br>Voltage   | V <sub>IH</sub> |  |                        | 4.5<br>to<br>5.5 | 2                             | _    | 2        |       | 2      | _    | V        |
| Low-Level Input<br>Voltage  | VıL             |  |                        | 4.5<br>to<br>5.5 | _                             | 0.8  |          | 0.8   |        | 0.8  | V        |
| High-Level Output   |                 | V <sub>IH</sub><br>or  | -0.05                  | 4.5              | 4.4                           |      | 4.4      | -     | 4.4    |      |          |
| Voltage   | V <sub>OH</sub> | V <sub>IL</sub>  | -24                    | 4.5              | 3.94                          |      | 3.8      | _     | 3.7    |      | V        |
|   |                 | #, * {   | -75                    | 5.5              |                               |      | 3.85     |       |        |      |          |
|   |                 |  | -50                    | 5.5              |                               |      |          | _     | 3.85   |      | <u> </u> |
| Low-Level Output  |                 | ViH  | 0.05                   | 4.5              |                               | 0.1  |          | 0.1   |        | 0.1  |          |
| Voltage   | $V_{OL}$        | or<br>V <sub>IL</sub>  | 24                     | 4.5              |                               | 0.36 |          | 0.44  |        | 0.5  | V        |
| _   |                 | #. * {   | 75                     | 5.5              |                               |      |          | 1.65  |        |      |          |
|   |                 | , l  | 50                     | 5.5              |                               |      |          |       |        | 1.65 |          |
| Input Leakage<br>Current  | t <sub>i</sub>  | V <sub>CC</sub><br>or<br>GND                                 |                        | 5.5              |                               | ±0.1 | <u> </u> | ±1    | _      | ±1   | μА       |
| 3-State Leakage<br>Current  | loz             | V <sub>IH</sub><br>or<br>V <sub>IL</sub><br>V <sub>O</sub> = |                        | 5.5              | _                             | ±0.5 |          | ±5    |        | ±10  | μΑ       |
|   | ·               | V <sub>cc</sub><br>or<br>GND                                 |                        |                  |                               |      |          |       |        |      |          |
| Quiescent Supply<br>Current, MSI  | lcc             | V <sub>∞</sub><br>or<br>GND                                  | 0                      | 5.5              |                               | 8    |          | 80    | _      | 160  | μΑ       |
| Additional Quiescent S<br>Current per Input Pir<br>TTL Inputs High<br>1 Unit Load |                 | V <sub>cc</sub> -2.1   | ·                      | 4.5<br>to<br>5.5 | _                             | 2.4  |          | 2.8   | _      | 3    | mA       |

<sup>#</sup>Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

\* Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

#### **ACT INPUT LOADING TABLES**

| CD54/74ACT240     |      |  |  |  |  |
|-------------------|------|--|--|--|--|
| INPUT UNIT LOADS* |      |  |  |  |  |
| nA0 - A3          | 1.42 |  |  |  |  |
| 10E               | 0.83 |  |  |  |  |
| 20E               | 0.83 |  |  |  |  |

| CD54/74ACT241    |      |  |  |  |  |  |
|------------------|------|--|--|--|--|--|
| INPUT UNIT LOADS |      |  |  |  |  |  |
| nA0 - A3         | 0.5  |  |  |  |  |  |
| 10E              | 0.83 |  |  |  |  |  |
| 20E              | 1.67 |  |  |  |  |  |

| CD54/74ACT244 |                   |  |  |  |  |  |
|---------------|-------------------|--|--|--|--|--|
| INPUT         | INPUT UNIT LOADS* |  |  |  |  |  |
| nA0 - A3      | 0.5               |  |  |  |  |  |
| 10E           | 0.83              |  |  |  |  |  |
| 20E           | 0.83              |  |  |  |  |  |

<sup>\*</sup>Unit load is ∆I<sub>∞</sub> limit specified in Static Characteristics Chart, e.g., 2.4 mA max. @ 25°C.

SWITCHING CHARACTERISTICS: AC Series;  $t_{\rm r}$   $t_{\rm r}$  = 3 ns,  $C_{\rm L}$  = 50 pF

|   |                                      |                    | AMBII                              | T                   |                 |                    |       |  |
|---|--------------------------------------|--------------------|------------------------------------|---------------------|-----------------|--------------------|-------|--|
| CHARACTERISTICS   | SYMBOL                               | V <sub>cc</sub>    |                                    | o +85               |                 | +125               | UNITS |  |
|   | '                                    | (V)                | MIN.                               | MAX.                | MIN.            | MAX.               | ]     |  |
| Propagation Delays:<br>Data to Outputs<br>AC240   | t <sub>PLH</sub>                     | 1.5<br>:3.3*<br>5† | 2.6<br>1.9                         | 82<br>9.2<br>6.5    | <br>2.5<br>1.8  | 90<br>10.1<br>7.2  | ns    |  |
| AC241, 244  | : tегн<br>tенс                       | 1.5<br>3.3<br>5    |                                    | 93<br>10.5<br>7.5   | _<br>2.9<br>2.1 | 103<br>11.5<br>8.2 | ns    |  |
| Output Enable Times   | t <sub>PZL</sub>                     | 1.5<br>3.3<br>5    | <br>4.6<br>3.1                     | 136<br>16.4<br>10.9 | _<br>4.5<br>3   | 150<br>18<br>12    | ns    |  |
| Output Disable Times  | t <sub>PLZ</sub><br>t <sub>PHZ</sub> | 1.5<br>3.3<br>5    | 3.9<br>3.1                         | 136<br>13.6<br>10.9 | <br>3.8<br>3    | 150<br>15<br>12    | ns    |  |
| Power Dissipation Capacitance<br>AC240<br>AC241, 244  | C <sub>PD</sub> §                    |                    | 65 Typ. 65 Typ.<br>71 Typ. 71 Typ. |                     | pF              |                    |       |  |
| Min. (Valley) V <sub>OH</sub> During Switching of Other Outputs (Output Under Test Not Switching) | V <sub>онv</sub><br>See<br>Fig. 1    | 5                  | 4 Typ. @ 25°C                      |                     |                 | v                  |       |  |
| Max. (Peak) V <sub>OL</sub> During Switching of Other Outputs (Output Under Test Not Switching)   | V <sub>OLP</sub><br>See<br>Fig. 1    | 5                  | 1 Тур. @ 25°С                      |                     |                 | V                  |       |  |
| Input Capacitance   | Cı                                   | _                  |                                    | 10                  | _               | 10                 | pF    |  |
| 3-State Output Capacitance  | Co                                   |                    |                                    | 15                  |                 | 15                 | pF    |  |

#### SWITCHING CHARACTERISTICS: ACT Series; t,, t, = 3 ns, C, = 50 pF

|   |                                      | V <sub>cc</sub><br>(V) | AMBI                            | (A) - °C   |      |      |       |
|---|--------------------------------------|------------------------|---------------------------------|------------|------|------|-------|
| CHARACTERISTICS   | SYMBOL                               |                        | -40                             | -40 to +85 |      | +125 | UNITS |
|   | }                                    |                        | MIN.                            | MAX.       | MIN. | MAX. |       |
| Propagation Delays:<br>Data to Outputs<br>ACT240  | t <sub>PLH</sub><br>t <sub>PHL</sub> | 5†                     | 2.3                             | 7.8        | 2.2  | 8.6  | ns    |
| ACT241, 244   | t <sub>PLH</sub><br>t <sub>PHL</sub> | 5                      | 2.5                             | 8.7        | 2.4  | 9.6  | ns    |
| Output Enable Times   | t <sub>PZL</sub>                     | 5                      | 3.5                             | 12.2       | 3.4  | 13.4 | ns    |
| Output Disable Times  | t <sub>PLZ</sub>                     | 5                      | 3.5                             | 12.2       | 3.4  | 13.4 | ns    |
| Power Dissipation Capacitance<br>ACT240<br>ACT241, 244  | C <sub>PO</sub> §                    |                        | 65 Typ. 65 Typ. 71 Typ. 71 Typ. |            |      | pF   |       |
| Min. (Valley) V <sub>он</sub> During Switching of Other Outputs (Output Under Test Not Switching) | V <sub>онv</sub><br>See<br>Fig. 1    | 5                      | 4 Typ. @ 25°C                   |            | v    |      |       |
| Max. (Peak) Vol. During Switching of Other Outputs (Output Under Test Not Switching)              | V <sub>OLP</sub><br>See<br>Fig. 1    | 5                      | 1 Typ. @ 25°C                   |            | v    |      |       |
| Input Capacitance   | Cı                                   |                        | _                               | 10         | _    | 10   | pF    |
| 3-State Output Capacitance  | Co                                   |                        | _                               | 15         | _    | 15   | ρF    |

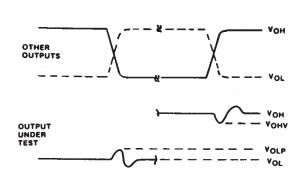
<sup>\*3.3</sup> V: min. is @ 3.6 V max. is @ 3 V

 $\ddagger C_{PD}$  is used to determine the dynamic power consumption, per package. For AC series:  $P_D = V_{CC}^2 \, f_i \, (C_{PD} + C_L)$  For ACT series:  $P_D = V_{CC}^2 \, f_i \, (C_{PD} + C_L) + V_{CC} \, \Delta I_{CC}$  where  $f_i$  = input frequency

†5 V: min. is @ 5.5 V max. is @ 4.5 V  $C_L$  = output load capacitance

 $V_{CC} = supply voltage$ 

#### PARAMETER MEASUREMENT INFORMATION



#### NOTES:

- VOHY AND VOLP ARE MEASURED WITH RESPECT TO A GROUND REFERENCE NEAR THE OUTPUT UNDER TEST.
   INPUT PULSES HAVE THE FOLLOWING CHARACTERISTICS:
- PRR ≤ 1 MHz, t<sub>1</sub> = 3 ns, t<sub>1</sub> = 3 ns, 5 KEW 1 ns.

  R.F. FIXTURE WITH 700-MHz DESIGN RULES REQUIRED.
  IC SHOULD BE SOLDERED INTO TEST BOARD AND BYPASSED WITH 0.1 F CAPACITOR. SCOPE AND PROBES REQUIRE 700-MHz BANDWIDTH.

9205-42406

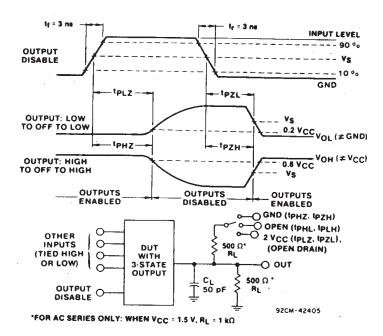
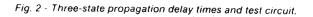
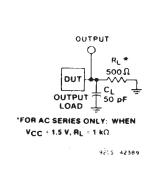
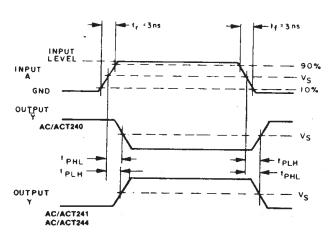


Fig. 1 - Simultaneous switching transient waveforms.







9205-42407

Fig. 3 - Propagation delay times and test circuit.

|                              | CD54/74AC           | <b>CD54/74ACT</b>   |
|------------------------------|---------------------|---------------------|
| Input Level                  | V <sub>cc</sub>     | 3 V                 |
| Input Switching Voltage, Vs  | 0.5 V <sub>cc</sub> | 1.5 V               |
| Output Switching Voltage, Vs | 0.5 V <sub>cc</sub> | 0.5 V <sub>CC</sub> |





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#### **PACKAGING INFORMATION**

| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish (6) | MSL Peak Temp                 | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|----------------------|-------------------------------|--------------|-------------------------|---------|
| CD54AC240F3A     | ACTIVE | CDIP         | J                  | 20   | 1              | TBD                        | A42                  | N / A for Pkg Type            | -55 to 125   | CD54AC240F3A            | Sample  |
| CD54AC244F3A     | ACTIVE | CDIP         | J                  | 20   | 1              | TBD                        | A42                  | N / A for Pkg Type            | -55 to 125   | CD54AC244F3A            | Sample  |
| CD54ACT240F3A    | ACTIVE | CDIP         | J                  | 20   | 1              | TBD                        | A42                  | N / A for Pkg Type            | -55 to 125   | CD54ACT240F3A           | Samples |
| CD54ACT241F3A    | ACTIVE | CDIP         | J                  | 20   | 1              | TBD                        | A42                  | N / A for Pkg Type            | -55 to 125   | CD54ACT241F3A           | Samples |
| CD54ACT244F3A    | ACTIVE | CDIP         | J                  | 20   | 1              | TBD                        | A42                  | N / A for Pkg Type            | -55 to 125   | CD54ACT244F3A           | Samples |
| CD74AC240E       | ACTIVE | PDIP         | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU            | N / A for Pkg Type            | -55 to 125   | CD74AC240E              | Samples |
| CD74AC240EE4     | ACTIVE | PDIP         | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU            | N / A for Pkg Type            | -55 to 125   | CD74AC240E              | Samples |
| CD74AC240M       | ACTIVE | SOIC         | DW                 | 20   | 25             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM            | -55 to 125   | AC240M                  | Samples |
| CD74AC240M96     | ACTIVE | SOIC         | DW                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM            | -55 to 125   | AC240M                  | Samples |
| CD74AC244E       | ACTIVE | PDIP         | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU            | N / A for Pkg Type            | -55 to 125   | CD74AC244E              | Samples |
| CD74AC244EE4     | ACTIVE | PDIP         | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU            | N / A for Pkg Type -55 to 125 |              | CD74AC244E              | Samples |
| CD74AC244M       | ACTIVE | SOIC         | DW                 | 20   | 25             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM            | -55 to 125   | AC244M                  | Samples |
| CD74AC244M96     | ACTIVE | SOIC         | DW                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM            | -55 to 125   | AC244M                  | Samples |
| CD74AC244M96G4   | ACTIVE | SOIC         | DW                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM            | -55 to 125   | AC244M                  | Samples |
| CD74ACT240E      | ACTIVE | PDIP         | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU            | N / A for Pkg Type            | -55 to 125   | CD74ACT240E             | Samples |
| CD74ACT240EE4    | ACTIVE | PDIP         | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU            | N / A for Pkg Type            | -55 to 125   | CD74ACT240E             | Samples |
| CD74ACT240M      | ACTIVE | SOIC         | DW                 | 20   | 25             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM            | -55 to 125   | ACT240M                 | Samples |
| CD74ACT240M96    | ACTIVE | SOIC         | DW                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM            | -55 to 125   | ACT240M                 | Samples |



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#### PACKAGE OPTION ADDENDUM

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| Orderable Device | Status | Package Type | _       | Pins | _    | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking | Samples |
|------------------|--------|--------------|---------|------|------|----------------------------|------------------|--------------------|--------------|----------------|---------|
|                  | (1)    |              | Drawing |      | Qty  | (2)                        | (6)              | (3)                |              | (4/5)          |         |
| CD74ACT240M96E4  | ACTIVE | SOIC         | DW      | 20   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -55 to 125   | ACT240M        | Samples |
| CD74ACT241E      | ACTIVE | PDIP         | N       | 20   | 20   | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | -55 to 125   | CD74ACT241E    | Samples |
| CD74ACT241M96    | ACTIVE | SOIC         | DW      | 20   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -55 to 125   | ACT241M        | Samples |
| CD74ACT244E      | ACTIVE | PDIP         | N       | 20   | 20   | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | -55 to 125   | CD74ACT244E    | Samples |
| CD74ACT244M      | ACTIVE | SOIC         | DW      | 20   | 25   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -55 to 125   | ACT244M        | Samples |
| CD74ACT244M96    | ACTIVE | SOIC         | DW      | 20   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -55 to 125   | ACT244M        | Samples |
| CD74ACT244M96E4  | ACTIVE | SOIC         | DW      | 20   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -55 to 125   | ACT244M        | Samples |
| CD74ACT244M96G4  | ACTIVE | SOIC         | DW      | 20   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -55 to 125   | ACT244M        | Samples |
| CD74ACT244MG4    | ACTIVE | SOIC         | DW      | 20   | 25   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -55 to 125   | ACT244M        | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

<sup>(3)</sup> MSL. Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



#### PACKAGE OPTION ADDENDUM

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- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF CD54AC240, CD54AC244, CD54ACT240, CD54ACT241, CD54ACT244, CD74AC240, CD74AC244, CD74ACT240, CD74ACT241, CD74ACT244:

- Catalog: CD74AC240, CD74AC244, CD74ACT240, CD74ACT241, CD74ACT244
- Military: CD54AC240, CD54AC244, CD54ACT240, CD54ACT241, CD54ACT244

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

## PACKAGE MATERIALS INFORMATION

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#### TAPE AND REEL INFORMATION





| Α0 |   |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device        | _    | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|---------------|------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| CD74AC240M96  | SOIC | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8       | 13.3       | 2.7        | 12.0       | 24.0      | Q1               |
| CD74AC244M96  | SOIC | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8       | 13.3       | 2.7        | 12.0       | 24.0      | Q1               |
| CD74ACT240M96 | SOIC | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8       | 13.3       | 2.7        | 12.0       | 24.0      | Q1               |
| CD74ACT241M96 | SOIC | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8       | 13.3       | 2.7        | 12.0       | 24.0      | Q1               |
| CD74ACT244M96 | SOIC | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8       | 13.3       | 2.7        | 12.0       | 24.0      | Q1               |

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\*All dimensions are nominal

| 7 til diffictiolofio die floriffiai |              |                 |      |      |             |            |             |
|-------------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device                              | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| CD74AC240M96                        | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| CD74AC244M96                        | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| CD74ACT240M96                       | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| CD74ACT241M96                       | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| CD74ACT244M96                       | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |

### 14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G20)

#### PLASTIC SMALL OUTLINE



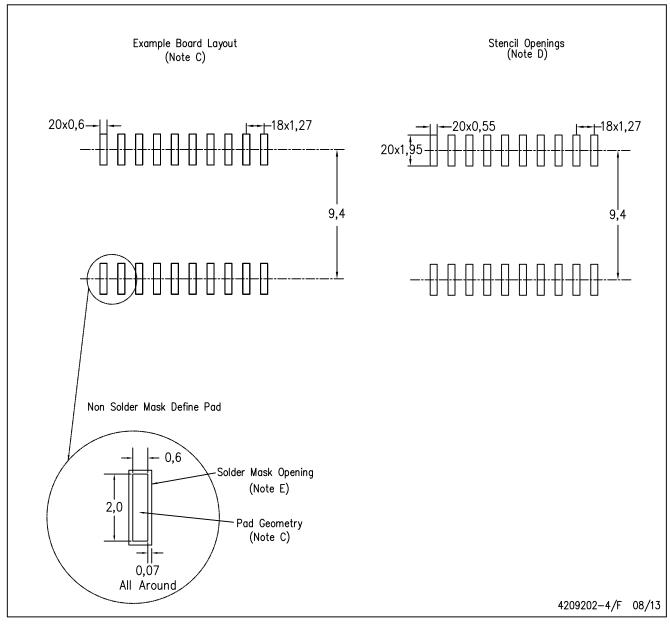
NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



## DW (R-PDSO-G20)

## PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Refer to IPC7351 for alternate board design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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